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H8/300L Super Low Power Series

Division of 32-Bit Binary Numbers (DIV)

Introduction

The software DIV divides a 32-bit binary number by another 32-bit binary number and places the result (a 32-bit binary number) in general-purpose registers.

Target Device

H8/38024

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1. Arguments

Description	Memory area	Data length (bytes)
Input	Dividend	R0, R1
	Divisor	R2, R3
Output	Result of division (Quotient)	R0, R1
	Result of division (Remainder)	R4, R5
	Errors	Z flag (CCR)

2. Changes to Internal Registers and Flags

R0	R1	R2	R3	R4	R5	R6	R7
○	○	×	×	○	○	—	—
I	U	H	U	N	Z	V	C
—	×	—	×	○	○	×	×

Legend

- : No change
- ×: Undefined
- : Result

3. Specifications

Program memory (bytes)	58
Data memory (bytes)	0
Stack (bytes)	0
Clock cycle count	1374
Reentrant	Possible
Relocation	Possible
Interrupt	Possible

4. Description

4.1 Details of functions

- The following arguments are used with the software DIV:
 - R0: Sets the upper 2 bytes of a 32-bit binary dividend. The upper 2 bytes of the result of division (quotient) are placed in this register after execution of the software DIV.
 - R1: Sets the lower 2 bytes of the 32-bit binary dividend. The lower 2 bytes of the result of division (quotient) are placed in this register after execution of the software DIV.
 - R2: Sets the upper 2 bytes of a 32-bit binary divisor as an input argument.
 - R3: Sets the lower 2 bytes of the 32-bit binary divisor as an input argument.
 - R4: The upper 2 bytes of the result of division (remainder) are placed in this register as an output argument.
 - R5: The lower 2 bytes of the result of division (remainder) are placed in this register as an output argument.
 - Z flag (CCR): Indicates the presence or absence of an error (division by 0) with the software DIV as an output argument.
 - Z flag = 1: The divisor was 0.
 - Z flag = 0: The divisor was not 0.

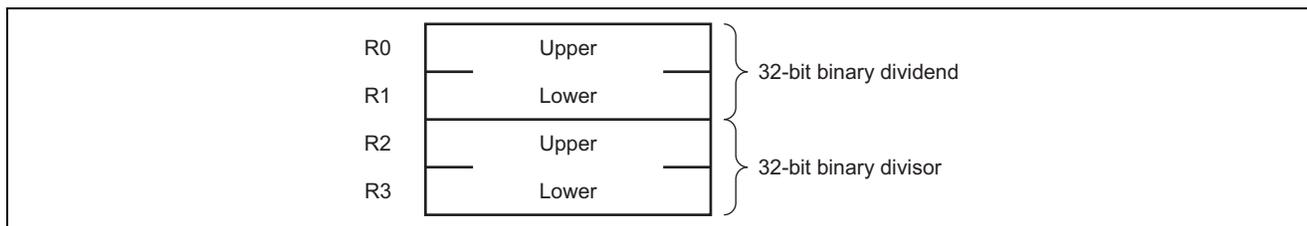


Figure 1 Input Argument Setting

- The following figure illustrates the execution of the software DIV. When the input arguments are set as shown in (1), the result of division is placed as shown in (2).

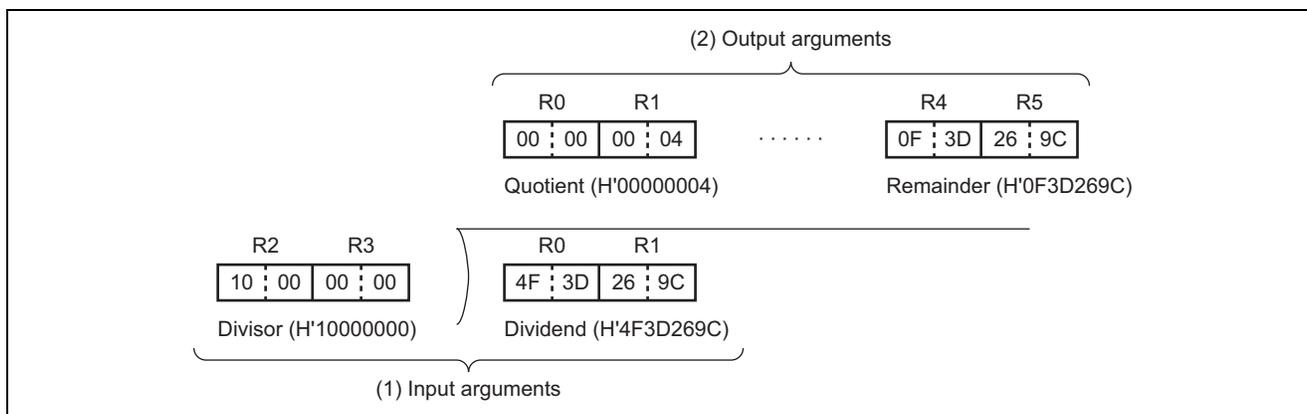


Figure 2 Example of Software DIV Execution

3. Table 1 lists the results of division with 0 placed in the input arguments.

Table 1 Results of Division with 0 Placed in Input Arguments

Input argument		Output argument		
Dividend (R0, R1)	Divisor (R2, R3)	Quotient (R0, R1)	Remainder (R4, R5)	Error (Z)
H'**** ****	H'0000 0000	H'**** ****	H'0000 0000	1
H'0000 0000	H'**** ****	H'0000 0000	H'0000 0000	0
H'0000 0000	H'0000 0000	H'0000 0000	H'0000 0000	1

Note: H'**** **** is a hexadecimal number.

4.2 Notes on usage

- When the upper bits are not used (see figure 3), set them to 0; otherwise, a correct result cannot be obtained because division is done on the numbers including indeterminate data.

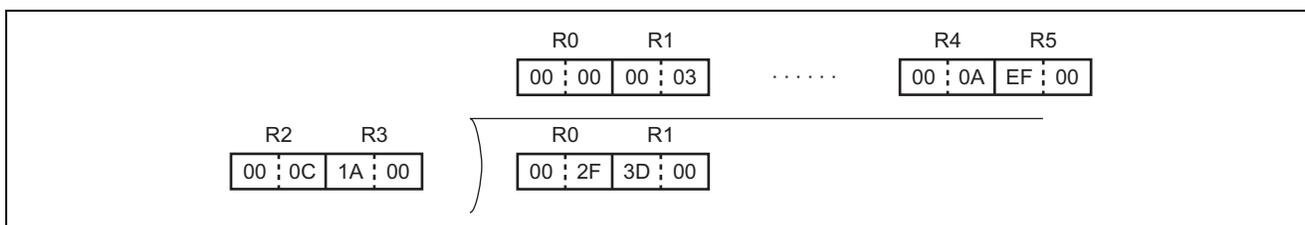


Figure 3 Example of Division with Upper Bits Unused

- After execution of the software DIV, the dividend will be lost because the quotient is placed in R0 and R1. When the dividend is still needed after software DIV execution, save it in memory.

4.3 Data memory

The software DIV uses no data memory.

4.5 Operation

1. A binary division can be done by performing a series of subtractions. Figure 4 shows an example of division (H'0D ÷ H'03).

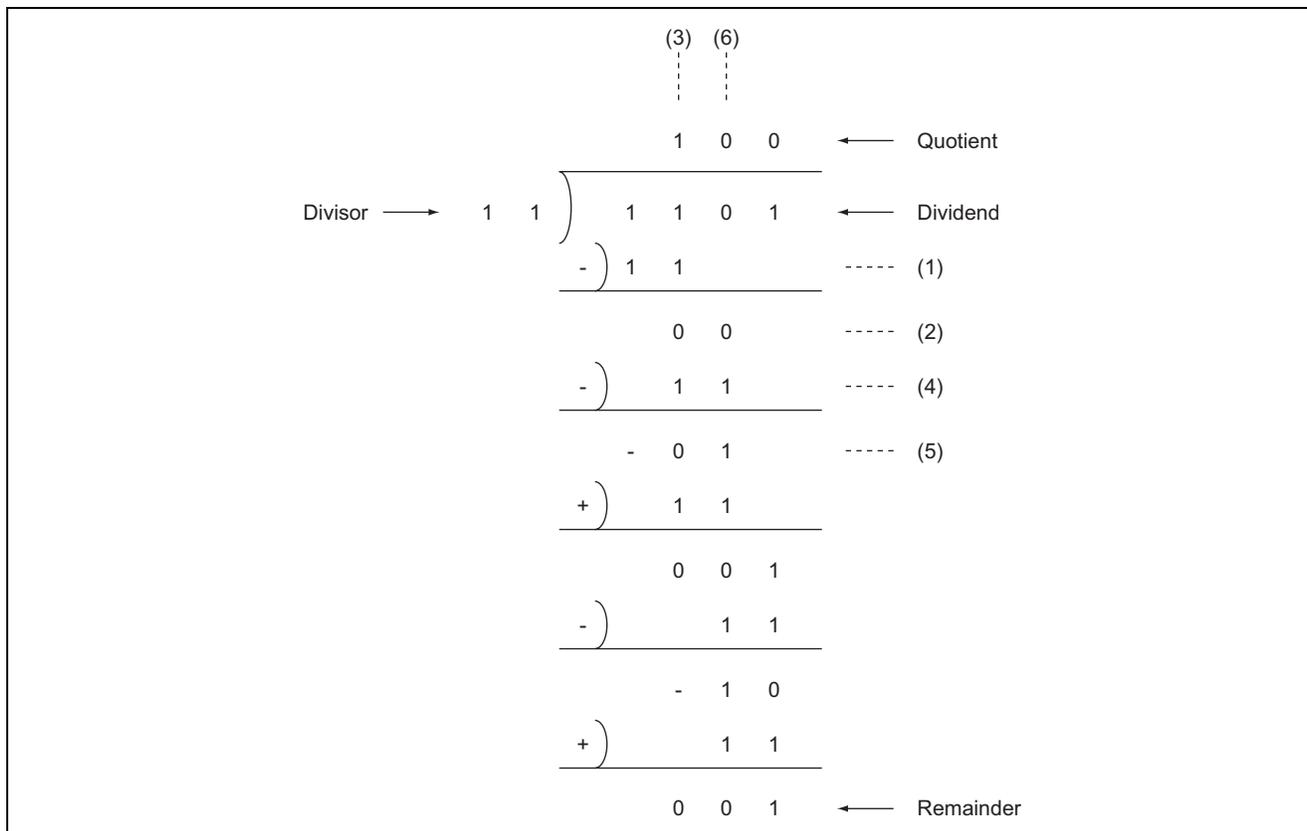
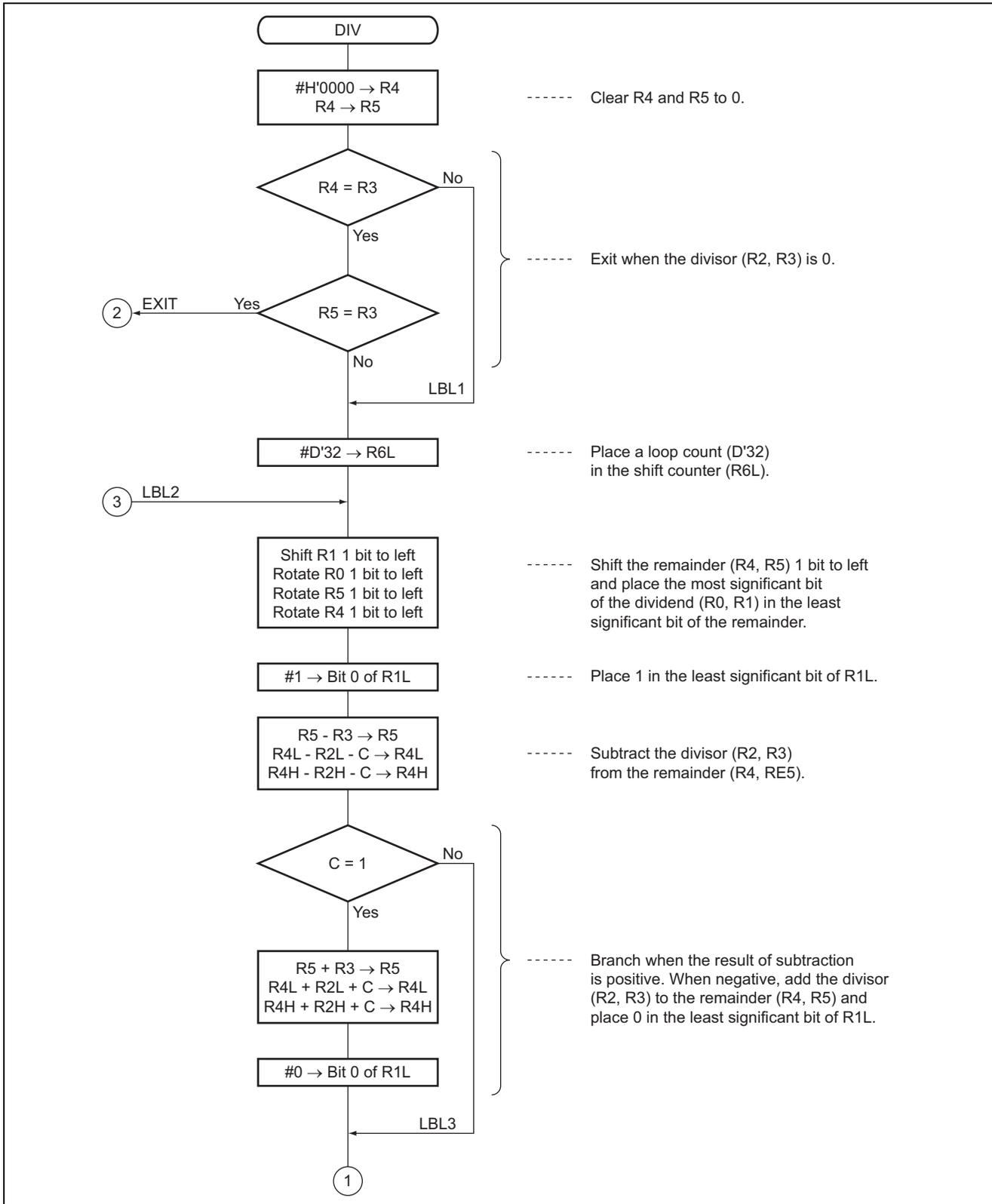


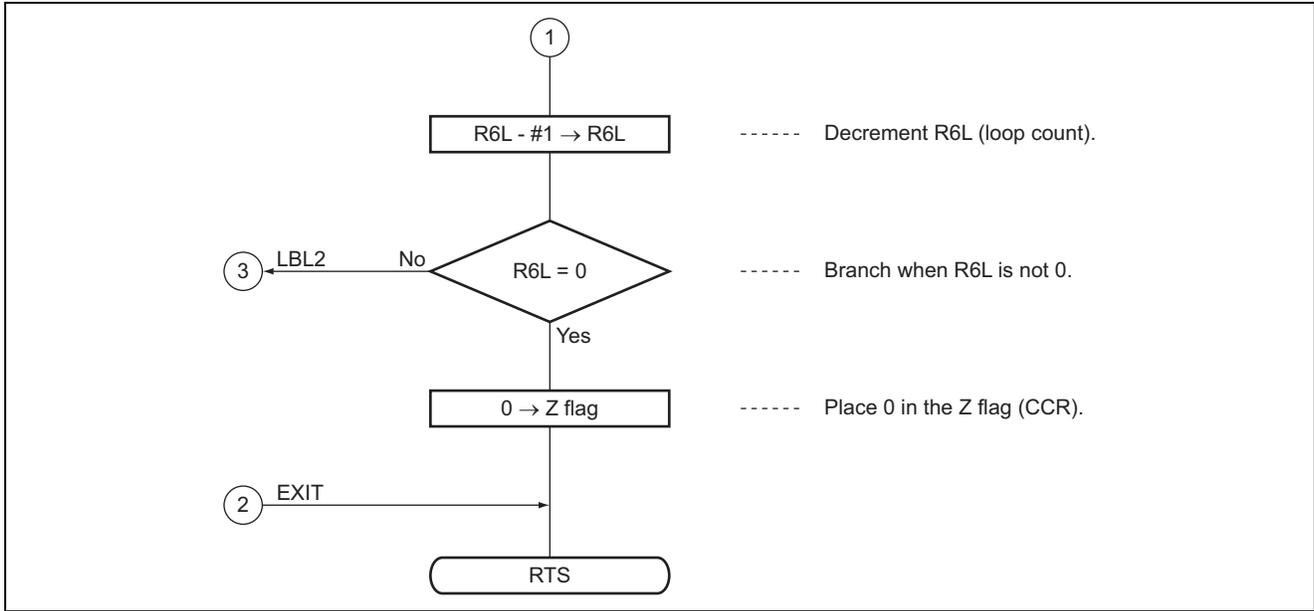
Figure 4 Example of Software DIV Execution (H'0D ÷ H'03)

This example indicates that the quotient and remainder are obtained by repeating a process of subtracting the dividend from the divisor. More specifically, the dividend is taken out bit by bit from the upper bits and the divisor is subtracted from the sum of the data extracted and the result of the previous subtraction.

2. The program runs in the following steps:
 - a. A shift count (D'32) is set.
 - b. The dividend is shifted 1 bit to the left and the MSB thus loaded to the C bit is set as the LSB of the remainder.
 - c. The divisor is subtracted from the remainder.
When the result is positive, the least significant bit of the dividend is set to 1 ((1) → (2) → (3) in figure 4).
When the result is negative, the least significant bit of the dividend is set to 0, and the divisor is added to the result, returning it to the state before the subtraction ((4) → (5) → (6) in figure 4).
 - d. The shift count (set in step a) is decremented.
 - e. Steps b to d are repeated until the shift count reaches H'00.

5. Flowchart





6. Program List

*** H8/300 ASSEMBLER VER 1.0B ** 08/18/92 09:58:57

PROGRAM NAME =

```

1          ;*****
2          ;*
3          ;*      00 - NAME      :32 BIT DIVISION (DIV)
4          ;*
5          ;*****
6          ;*
7          ;*      ENTRY      :R0 (UPPER WORD DIVIDEND)
8          ;*
9          ;*
10         ;*      R1 (LOWER WORD DIVIDEND)
11         ;*
12         ;*      R2 (UPPER WORD DIVISOR)
13         ;*
14         ;*      R3 (LOWER WORD DIVISOR)
15         ;*
16         ;*      RETURNS    :R0 (UPPER WORD QUOTIENT)
17         ;*
18         ;*      R1 (LOWER WORD QUOTIENT)
19         ;*
20         ;*      R2 (UPPER WORD RESIDUE)
21         ;*
22         ;*      R3 (LOWER WORD RESIDUE)
23         ;*
24         ;*      Z flag OF CCR (Z=0;TRUE , Z=1;FALSE)
25         ;*
26         ;*****
27         ;
28         DIV_code C      0000          .SECTION          DIV_code, CODE, ALIGN=2
29         .EXPORT  DIV
30         ;
31         DIV_code C      00000000  DIV  .EQU $          ;Entry point
32         DIV_code C      0000 79040000  MOV.W   #H'0000,R4      ;Clear R4
33         DIV_code C      0004 0D45      MOV.W   R4,R5          ;Clear R5
34         DIV_code C      0006 1D42      CMP.W   R4,R2
35         DIV_code C      0008 4604      BNE    LBL1          ;Branch if Z flag = 0
36         DIV_code C      000A 1D43      CMP.W   R4,R3
37         DIV_code C      000C 472A      BEQ    EXIT          ;Branch if Z flag = 1 then exit
38         DIV_code C      000E          LBL1
39         DIV_code C      000E FE20      MOV.B   #D'32,R6L     ;Set byte counter
40         DIV_code C      0010          LBL2
41         DIV_code C      0010 1009      SHLL   R1L          ;Shift dividend 1 bit left
42         DIV_code C      0012 1201      ROTXL  R1H
43         DIV_code C      0014 1208      ROTXL  R0L
44         DIV_code C      0016 1200      ROTXL  R0H
45         ;
46         DIV_code C      0018 120D      ROTXL  R5L
47         DIV_code C      001A 1205      ROTXL  R5H
48         DIV_code C      001C 120C      ROTXL  R4L
49         DIV_code C      001E 1204      ROTXL  R4H
50         ;
51         DIV_code C      0020 7009      BSET   #0,R1L        ;Bit set bit 0 of R1L
52         ;
53         DIV_code C      0022 1935      SUB.W  R3,R5          ;R5 - R3 -> R5
54         DIV_code C      0024 1EAC      SUBX.B R2L,R4L        ;R4L - R2L - C -> R4L
55         DIV_code C      0026 1E24      SUBX.B R2H,R4H        ;R4H - R2H - C -> R4H

```

```

48                                     ;
49 DIV_code C    0028 4408             BCC     LBL3             ;Branch if C = 0
50 DIV_code C    002A 0935             ADD.W   R3,R5           ;R3 + R5 -> R3
51 DIV_code C    002C 0EAC             ADDX.B  R2L,R4L        ;R2L + R4L + C -> R4L
52 DIV_code C    002E 0E24             ADDX.B  R2H,R4H        ;R2H + R4H + C -> R4H
53                                     ;
54 DIV_code C    0030 7209             BCLR    #0,R1L         ;Bit clear bit 0 of R1L
55 DIV_code C    0032                   LBL3
56 DIV_code C    0032 1A0E             DEC.B   R6L             ;Decrement R6L
57 DIV_code C    0034 46DA             BNE     LBL2           ;Branch if Z=0
58 DIV_code C    0036 06FB             ANDC    #B'11111011,CCR ;Clear Z flag
59 DIV_code C    0038                   EXIT
60 DIV_code C    0038 5470             RTS
61                                     ;
62                                     .END
****TOTAL ERRORS 0
****TOTAL WARNINGS 0

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